

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0753414676](#)
Status: **Active**
Overview: [gbx_backplane_connector_system](#)
Description: 1.85mm by 1.85mm (.073 by .073") Pitch 4-Pair GbX® Backplane Connector System, Power Module, 12 Circuits, 1.27µm (50µ") Gold (Au)

Documents:
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)
[Product Specification PS-75221-999 \(PDF\)](#)

Agency Certification

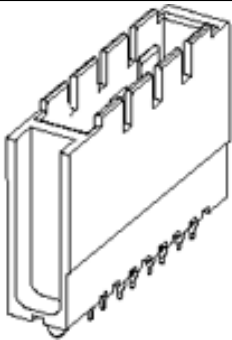
UL E29179

General

Product Family Backplane Connectors
Series [75341](#)
Application Backplane
Application Tooling Documents Tooling Manual
Comments Blade Length A 4.50mm, B 6.00mm, C 7.50mm, D 6.00mm
Component Type Power Header
Overview [gbx_backplane_connector_system](#)
Product Name GbX®
Style N/A

Physical

Circuits (Loaded) 8
Circuits (maximum) 8
Circuits Detail Rows A, B, C, & D
Color - Resin Gray
Durability (mating cycles max) 200
First Mate / Last Break Yes
Flammability 94V-0
Guide to Mating Part No
Keying to Mating Part None
Material - Plating Mating Gold
Material - Plating Termination Tin-Lead
Material - Resin High Temperature Thermoplastic
Number of Columns N/A
Number of Pairs 4
Number of Rows 4
Orientation Vertical
PC Tail Length (in) 0.089 In
PC Tail Length (mm) 2.28 mm
PCB Locator Yes
PCB Retention Yes
PCB Thickness Recommended (in) 0.063 In
PCB Thickness Recommended (mm) 1.60 mm
Packaging Type Tube
Pitch - Mating Interface (in) 0.073 In
Pitch - Mating Interface (mm) 1.85 mm
Pitch - Term. Interface (in) 0.102 In
Pitch - Term. Interface (mm) 2.60 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25



Series

image - Reference only

EU RoHS
RoHS Compliant by Exemption
REACH SVHC
Not Reviewed
Halogen-Free
Status
Not Reviewed

China RoHS

Pb

Need more information on product environmental compliance?
Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, [click here](#)
Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series
[75341Series](#)

Mates With
[75292 GbX® Daughtercard](#)

Application Tooling FAQ	
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.	
Global	
Description	Product #
Insertion Module, GbX® 4 pair 1- Up Power Module	0622022005
GbX® Single Pin Repair Tool	0622022090
GbX® Shield Removal Tool	0622022100

Plating min: Termination (μin)	30
Plating min: Termination (μm)	0.75
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	6A
Data Rate	8.0 Gbps
Real Signals (per 25mm)	0
Shielded	No
Voltage - Maximum	120V AC (RMS)/DC

Material Info

Reference - Drawing Numbers

Product Specification	PS-75221-999
Sales Drawing	SD-75341-001

GbX is a registered trademark of Amphenol Corporation.

This document was generated on 05/13/2010
PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION



ADDED NOTES 9 & 10 EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J. B. INGHAM 2007/08/31	DESCRIPTION REV	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
				mm	INCH	DRAWN BY ELO	DATE 2006/04/06	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY	
			4 PLACES	± ---	± ---	CHECKED BY	DATE		
			3 PLACES	± ---	± ---	ELO	2005/02/22		
			2 PLACES	± ---	± ---	APPROVED BY	DATE		
			1 PLACE	± ---	± ---	CUNNINGHAM	2005/02/23	MOLEX INCORPORATED	
			ANGULAR ± ---°		MATERIAL NO.		DOCUMENT NO.		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE B		SD-75341-001		1 OF 4			
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									

10 9 8 7 6 5 4 3 2 1



2-UP ASSEMBLY PART NUMBER

7 5 3 4 2 - A B C D

- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID
4 = 4.5 mm WIPE
6 = 6.0 mm WIPE
7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID
2 = 4.5 mm WIPE
3 = 6.0 mm WIPE
5 = 7.5 mm WIPE



SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-0426 DRAWN: STEWART CHKD: J. B. INGHAM APPR: J. B. INGHAM	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)				DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
			mm		INCH		DRAWN BY	DATE	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY		
			4 PLACES	± ---	± ---	ELO	2006/04/06				
			3 PLACES	± ---	± ---	CHECKED BY	DATE				
			2 PLACES	± ---	± ---	ELO	2005/02/22				
			1 PLACE	± ---	± ---	APPROVED BY	DATE	MOLEX INCORPORATED			
			ANGULAR ± ---°		CUNNINGHAM	2005/02/23					
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		MATERIAL NO.		DOCUMENT NO.			SHEET NO. 2 OF 4	
					SEE CHART		SD-75341-001				
					SIZE B		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				



COLUMN 1
COLUMN 2
COLUMN 3
COLUMN 4
COLUMN 5
COLUMN 6

SEE NOTE 4.



SEE NOTE 8.

3-UP ASSEMBLY PART NUMBER

7 5 3 4 3 - A B C D

- TIN/LEAD PLATED PRODUCT -

FOR EACH ROW LOCATION A, B, C, D:

0 = VOID

4 = 4.5 mm WIPE

6 = 6.0 mm WIPE

7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -

FOR EACH ROW LOCATION A, B, C, D:

0 = VOID

2 = 4.5 mm WIPE

3 = 6.0 mm WIPE

5 = 7.5 mm WIPE



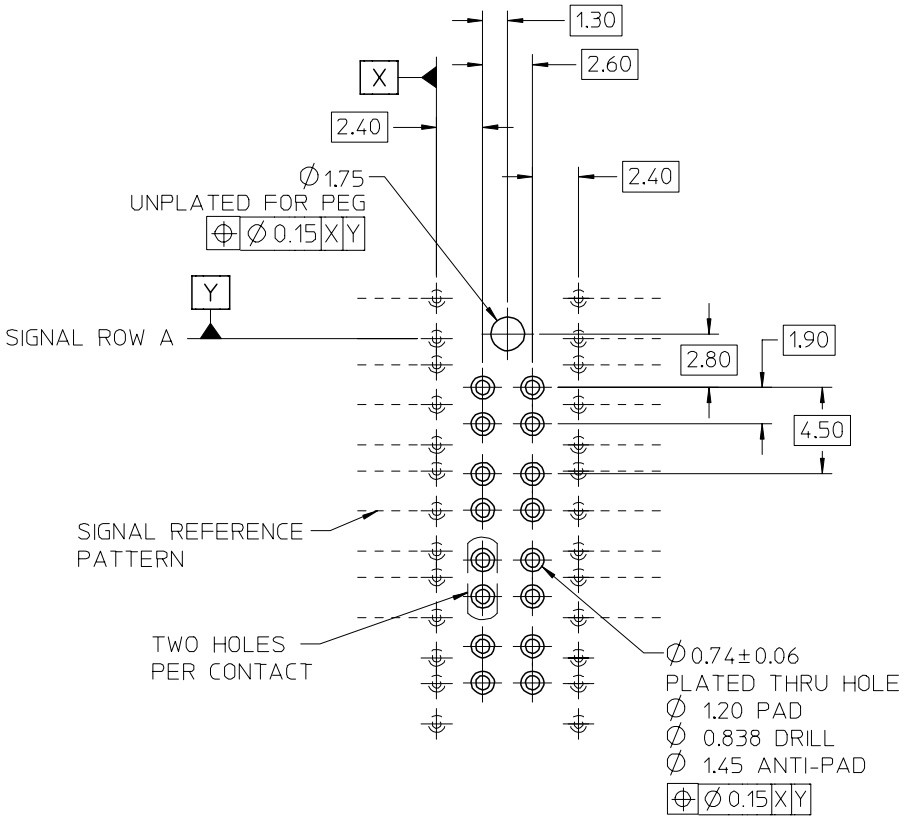
SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-0426 DRW: J. STEWART 2007/08/29 CHKD: J. STEWART 2007/08/30 APPR: J. INGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY ELO	DATE 2006/04/06	GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY				
			4 PLACES	± ---	± ---	CHECKED BY	DATE					
			3 PLACES	± ---	± ---	ELO	2005/02/22					
			2 PLACES	± ---	± ---	APPROVED BY	DATE					
			1 PLACE	± ---	± ---	CUNNINGHAM	2005/02/23	 MOLEX INCORPORATED	SD-75341-001			
			ANGULAR ± ---°		MATERIAL NO.		DOCUMENT NO.					SHEET NO. 3 OF 4
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART		SIZE B					THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION
			REV									



HOLE PATTERN FOR 1-UP ASSEMBLY

- 1.) ADD 7.40 FROM CENTERLINES OF PEGS FOR MULTIPLE UP ASSEMBLIES.
2.) ADD 5.55 FROM CENTERLINE TO CENTERLINE OF PEG
FOR INDIVIDUAL POWER MODULES STACKED NEXT
TO EACH OTHER.



ADDED $\varnothing 0.74 \pm 0.06$ EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J. BINGHAM 2007/08/31	QUALITY SYMBOLS $\nabla=0$ $\nabla=0$	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY ELO	DATE 2006/04/06	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY	
		4 PLACES	$\pm$ ---	$\pm$ ---		CHECKED BY ELO	DATE 2005/02/22		
		3 PLACES	$\pm$ ---	$\pm$ ---		APPROVED BY CUNNINGHAM	DATE 2005/02/23	MOLEX INCORPORATED	
REV C	DESCRIPTION	2 PLACES	$\pm$ ---	$\pm$ ---		MATERIAL NO.	DOCUMENT NO.		
		1 PLACE	$\pm$ ---	$\pm$ ---		SEE PREVIOUS		SD-75341-001	
		ANGULAR $\pm$ ----		$\pm$ ----		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		SHEET NO. 4 OF 4	
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS							

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9